Si nanocrystal (nc-Si) embedded in a SiO2 thin film is synthesized with low-energy Si ion implantation. Depth profiling of the charging effect of the nc-Si is determined from X-ray photoemission measurement. It is observed that there is a strong correlation between the depth profile of the charging effect and the nc-Si depth distribution. The charging effect is found to decrease with the increase of nc-Si concentration and to vanish when a densely stacked nanocrystal layer is formed. The phenomenon is attributed to the charge diffusion among the nanocrystals. The charge diffusion in the nanocrystal layer may have an important implication for nanocrystal flash memory. When such a layer is used as the charge-storage layer in the memory cells, the stored charges could be lost due to the rapid charge diffusion among the nc-Si if a single defect exists in the tunneling oxide, causing a reliability problem in data retention.

A 30 nm SiO2 thin film was thermally grown in dry oxygen at 950 °C on a p-type Si(100) wafer. Si+ ions with a dose of 8 \times 10^{16} \text{ cm}^{-2} were then implanted into the SiO2 thin film at 1 keV. Thermal annealing was carried out in N2 ambient at 1000 °C for 80 min to induce nc-Si formation. XPS measurement was performed by using a Kratos AXIS spectrometer with monochromatic Al Kα (1486.71 eV) X-ray radiation. Si 2p core level spectra were recorded at various depths. C 1s spectra due to the surface carbon contamination were also rerecorded as a reference for the X-ray-induced charging effect on the sample surfaces. The depth profiling was achieved by Ar ion sputtering, which was carried out with the XPS measurement in situ. The XPS data were recorded every 1 nm in depth.

The depth distribution of the implanted Si in the SiO2 thin film after the annealing has been determined with both the secondary ion mass spectroscopy (SIMS) and the stopping and range of ions in matter (SRIM) simulation, and the results are also compared with the sum of the relative concentrations of Si nanocrystal (Si0) and the Si suboxides (Si^{n+}, n = 1, 2, and 3) determined from the XPS analysis, as shown in Figure 1a. As can be seen in the figure, the results obtained with the three different techniques are consistent, and the excess Si is mainly distributed from the depth of ~2 nm to the depth of ~10 nm with the peak concentration located at the depth of 4–6 nm. Note that there is not much change in the depth profile after a thermal annealing due to the very low Si diffusion rate in the SiO2 matrix.9 On the other hand, a densely stacked nc-Si layer (i.e., the above-mentioned region of the depths of ~2 to ~10 nm) can be clearly seen in the transmission electron microscopy (TEM) image that is shown in Figure 1b.

It has been known that X-ray irradiation can cause charging in both the SiO2/Si system10–12 and the nc-Si/SiO2 system.13–15 For the system of nc-Si embedded in a SiO2 matrix, photoemission will leave positive charges in the nanocrystals, leading to a core-level shift to a higher binding energy. The C 1s core level shift shown in Figure 2 is an indicator of the charging effect. The C 1s core level on pure SiO2 surface has a shift of ~0.8 eV relative to the C 1s reference, while it shows a shift of ~1.9 eV on the surface of the sample of nc-Si embedded in SiO2. This indicates that the charging effect is greatly enhanced by the introduction of nc-Si into the SiO2 matrix. To monitor the charging effect underneath the surface, C 1s cannot be used as there is no sufficient carbon impurity below a certain depth.
in the Si-implanted SiO$_2$ sample. However, as discussed later, the core level shift of the oxidation state of Si$^{4+}$, which is caused by the charging effect, can be used for the depth profiling of the charging effect.

Panels a–c in Figure 3 show the XPS Si 2p core level peaks obtained on the surface and at the depths of 4 and 8 nm, respectively. Five oxidation states Si$^{n+}$ ($n = 0, 1, 2, 3,$ and 4) corresponding to the five chemical structures including Si (i.e., Si nanocrystal here), Si$_2$O, SiO, Si$_2$O$_3$, and SiO$_2$, respectively, could exist in the Si-implanted SiO$_2$ films. With the possible existence of the five oxidation states in mind, we have carried out the curve fitting by decomposing the spectrum into the Si 2p$_{1/2}$ and 2p$_{3/2}$ partner lines for the five oxidation states following the reported fitting procedure. The spin–orbit splitting is fixed at 0.6 eV and the Si 2p$_{1/2}$ and 2p$_{3/2}$ intensity ratio is set to 1/2 for all of the five oxidation states. For a clear presentation, the Si 2p$_{1/2}$ and 2p$_{3/2}$ partner lines are recombined into one peak for all five oxidation states in Figure 3. The XPS Si 2p spectra at different depths are deconvoluted based on the above approach. The deconvolution of the spectra on the surface and at the depths of 4 and 8 nm is also shown in Figure 3.

As can be observed in Figure 3, the peak areas of the five oxidation states change with the depth, showing that the concentrations of the five oxidation states vary with the depth. The depth profile of the relative concentration of each oxidation state can be obtained by calculating the ratio of $(I_{Si^{n+}}/I_{total})$ ($n = 0, 1, 2, 3,$ and 4) at various depths where $I_{Si^{n+}}$ is the peak
The Si0 shift relative to the reference of bulk crystalline Si as can vanish when a densely stacked nanocrystal layer is formed. This suggests that the charging effect is reduced with the increase of nanocrystal concentration, the Si1+ shift, and the Si0 shift, respectively.

Figure 4. Si1+ and Si0 shifts relative to the references (i.e., the Si 2p core level in pure SiO2 and the Si 2p core level in bulk Si) at various depths. The depth profile of nc-Si (i.e., the Si0) concentration is included for comparison. The triangles, squares and circles represent the nc-Si concentration, the Si1+ shift, and the Si0 shift, respectively.

The influence of the nanocrystal distribution on the charging effect is explained in the following. As illustrated in Figure 5, charge diffusion can take place due to the charge transfer from the charged nanocrystals to the adjacent uncharged nanocrystals by tunneling or other transport mechanisms. In the densely stacked nanocrystal layer, the charge induced by the photoemission can easily diffuse out to the nanocrystals that are not under the X-ray illumination, and thus the charge can be dissipated quickly, leading to a drastic reduction in the charging effect. For those nanocrystals distributed in the surface region and in the region deeper than ~10 nm, their concentrations are much lower, they are separated from each other with a larger spacing, and thus the charge diffusion is much more difficult to occur. Therefore, the charging effect is much more significant in the two regions.

The rapid charge diffusion in the densely stacked nanocrystal layer may have an important implication for nanocrystal flash memory devices in which the nanocrystal layer is synthesized with ion implantation. In such a device, to achieve a large memory window, a high-dose (normally more than 2 \times 10^{16} \text{ cm}^{-2}) low-energy (lower than ~2 keV) ion implantation into a SiO2 thin film is used to synthesize the nanocrystal layer embedded in the gate oxide.7,8,22,23 It is generally believed that the stored charge is maintained in the individual nanocrystal such that a single defect in the tunnel oxide will not cause the charge lose of the entire nanocrystal layer within the device. However, with the rapid charge diffusion in the nanocrystal layer, the entire nanocrystal layer could be discharged via the defect leakage path, leading to a serious problem in charge retention.

In conclusion, for nc-Si embedded in a SiO2 thin film synthesized with low-energy ion implantation, there is a strong correlation between the depth profile of the charging effect and the nc-Si depth distribution. The charging effect is reduced with the increase of nc-Si concentration, and it is found to vanish when a densely stacked nanocrystal layer is formed. The phenomenon is attributed to the charge diffusion due to the charge transfer from the charged nanocrystals to the adjacent uncharged nanocrystals. In the densely stacked nanocrystal layer, the charge induced by the photoemission can easily diffuse out to the nanocrystals that are not under the X-ray illumination, and thus the charge can be dissipated quickly, leading to a drastic reduction in the charging effect. This may have an important implication for nanocrystal flash memory. When such a layer...
is used as the charge-storage layer in a memory cell, the stored charge could be lost due to the rapid charge diffusion among the nc-Si if a defect exists in the underlying tunneling oxide, causing a reliability problem in data retention.

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References and Notes